

BPIX Module Testing Status - Week 44

5th November 2007

Production overview

Production Status: 863 modules produced (740 full/ 123 half)

- 510/138 graded as A/B → 88% || 86/24 → 89%
- 92 graded as C → 12% || 13 → 11%

Module Testing Report of Week 44:

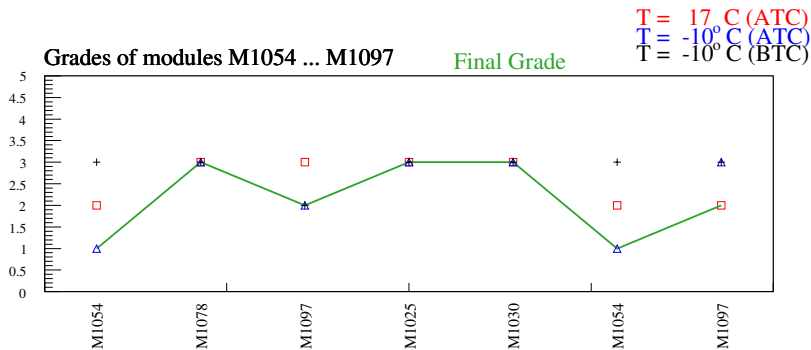
- 7 modules fully tested and therm. cycled (0 retested)

	Modules (3)			Halfmodules (4)		
Grade	A	B	C	A	B	C
T = -10° C, BTC*	2	1	0	4	0	0
T = -10° C, ATC	1	1	1	3	0	1
T = +17° C, ATC	2	1	0	2	2	0
Final Grade	1	1	1	2	1	1

- no retests with new DAC settings

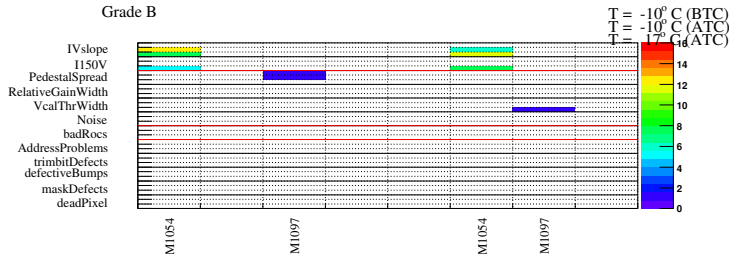
*without IV-criteria

Production summary

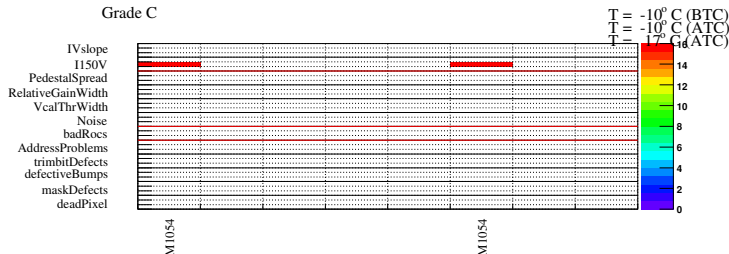


Module Failures Overview

Grade B



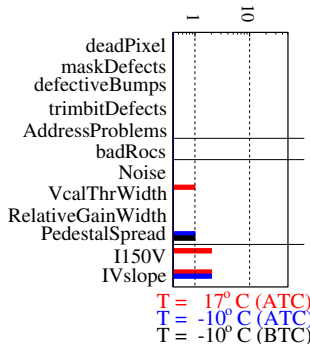
Grade C



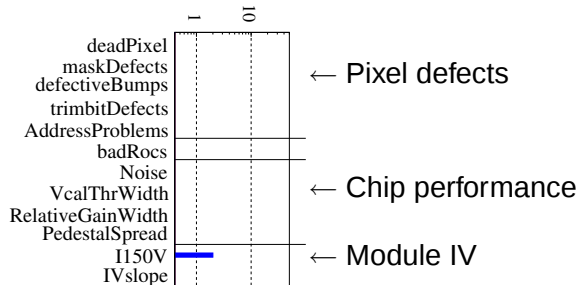
Production quality

Chip Failures

Grade B
Grade B



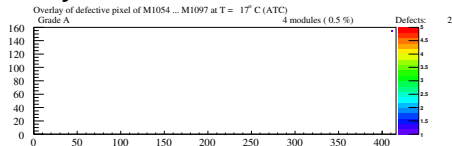
Grade C
Grade C



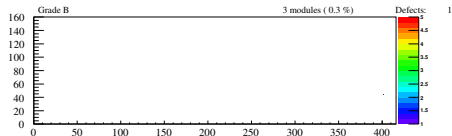
Defective pixel $T = 17^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = +17^{\circ}\text{C}$ (ATC)

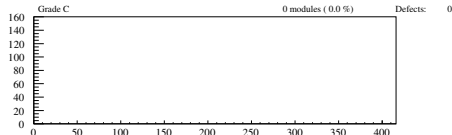
Grade A
(4 modules)



Grade B
(3 modules)



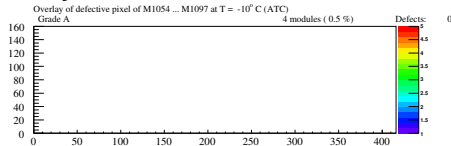
Grade C
(0 modules)



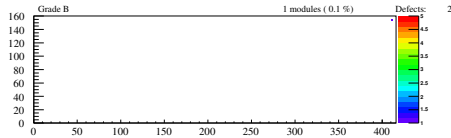
Defective pixel $T = -10^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = -10^{\circ}\text{C}$ (ATC)

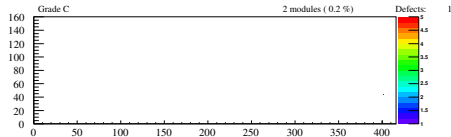
Grade A
(4 modules)



Grade B
(1 modules)



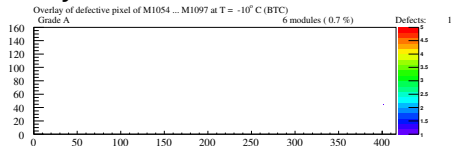
Grade C
(2 modules)



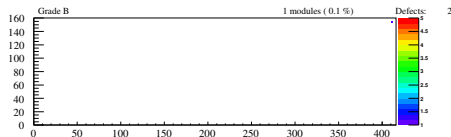
Defective pixel $T = -10^0\text{C}$ (BTC)

Overlay of all fully tested modules at $T = -10^0\text{C}$ (BTC)

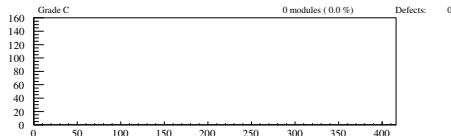
Grade A
(6 modules)



Grade B
(1 modules)



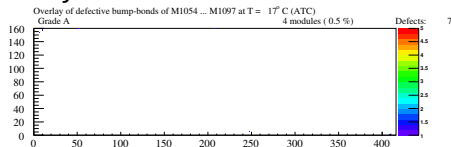
Grade C
(0 modules)



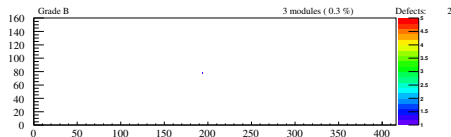
Defective bump-bonds $T = 17^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = +17^{\circ}\text{C}$ (ATC)

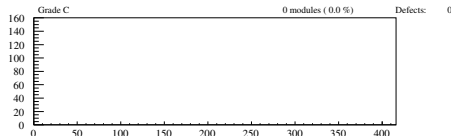
Grade A
(4 modules)



Grade B
(3 modules)



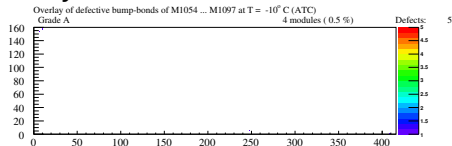
Grade C
(0 modules)



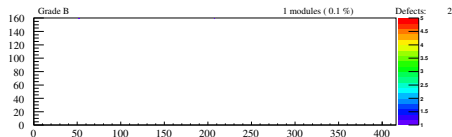
Defective bump-bonds $T = -10^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = -10^{\circ}\text{C}$ (ATC)

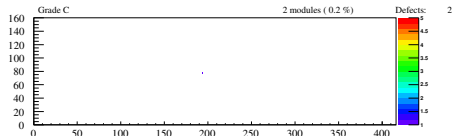
Grade A
(4 modules)



Grade B
(1 modules)



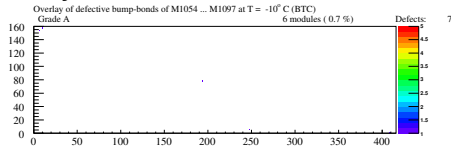
Grade C
(2 modules)



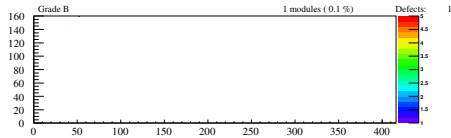
Defective bump-bonds $T = -10^{\circ}\text{C}$ (BTC)

Overlay of all fully tested modules at $T = -10^{\circ}\text{C}$ (BTC)

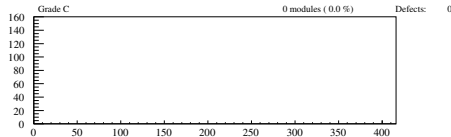
Grade A
(6 modules)



Grade B
(1 modules)



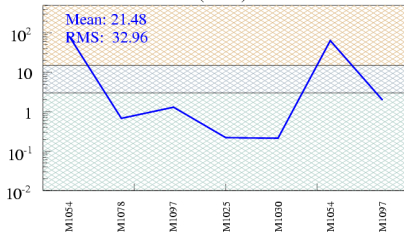
Grade C
(0 modules)



Current at 150 V

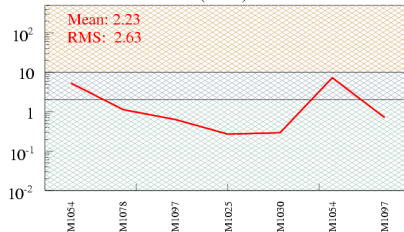
Current at 150 V (in μA) at $T = 17^\circ\text{C}$ and $T = -10^\circ\text{C}$

I150V at $T = -10^\circ\text{C}$ (ATC)



recalculated

I150V at $T = 17^\circ\text{C}$ (ATC)

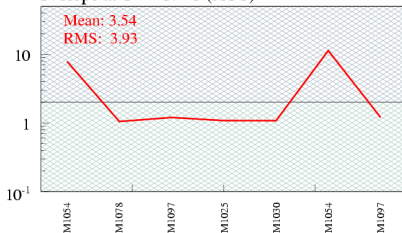


measured

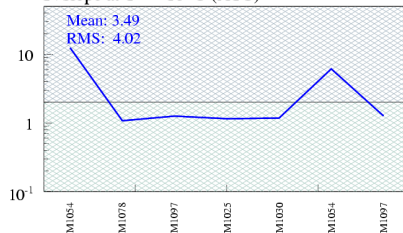
Slope of IV-Curve

Slope of IV-Curve at $T = 17^{\circ}\text{C}$ and $T = -10^{\circ}\text{C}$

IVslope at $T = 17^{\circ}\text{C}$ (ATC)

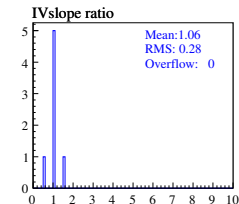
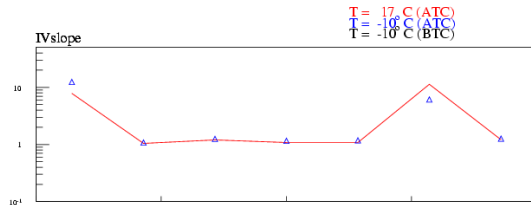
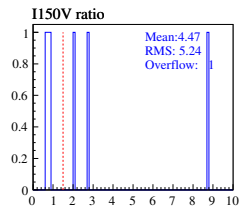
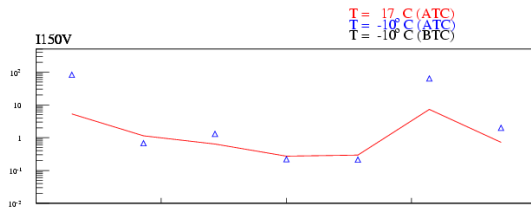


IVslope at $T = -10^{\circ}\text{C}$ (ATC)



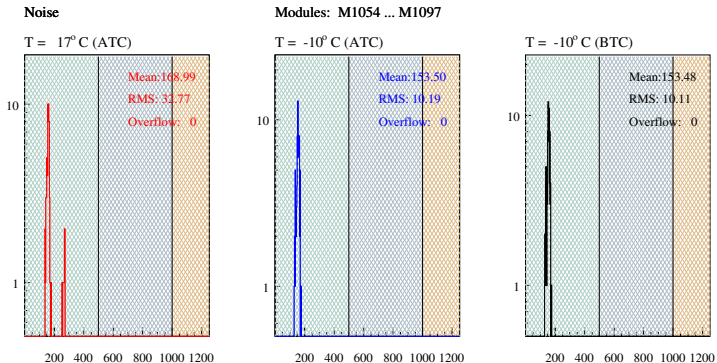
Current recalculation to $T = 17^{\circ}\text{C}$

Cross check of recalculated values with measured values



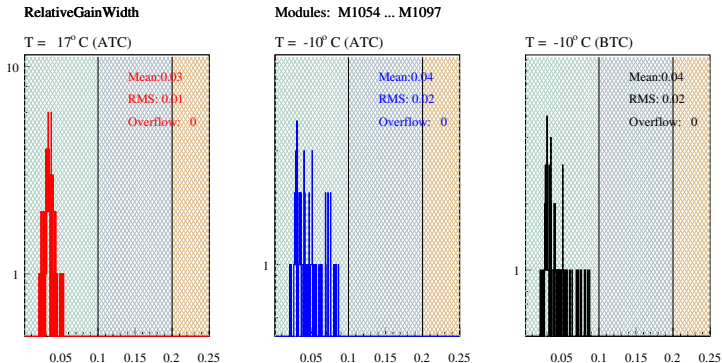
Noise

MeanNoise of chips



Relative Gain Width

RelativeGainWidth of chips



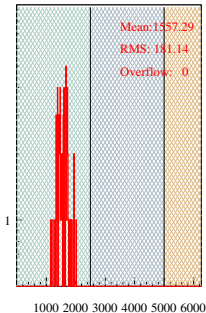
Rel. Gain Width in %

Pedestal Spread

PedestalSpread of chips

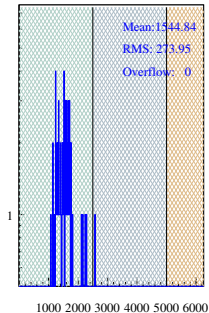
PedestalSpread

T = 17° C (ATC)

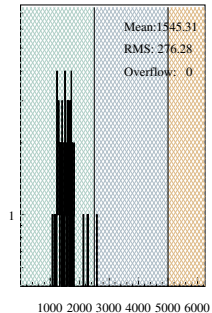


Modules: M1054 ... M1097

T = -10° C (ATC)



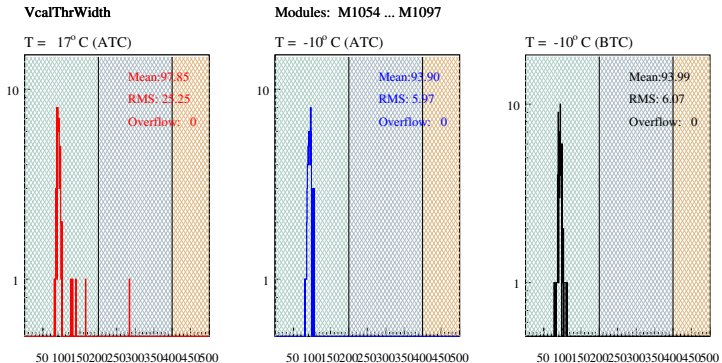
T = -10° C (BTC)



Pedestal Spread in e^-

Vcal Threshold Width

VcalThresholdWidth of chips

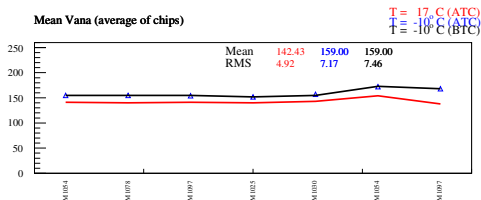


Vcal Thr. Width in e^-

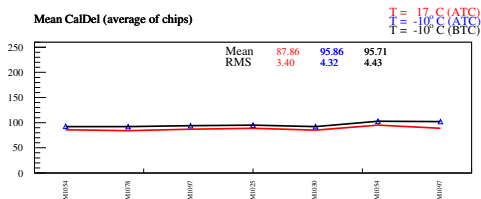
Operational parameters I

Mean DACs I

Mean Vana (average of chips)



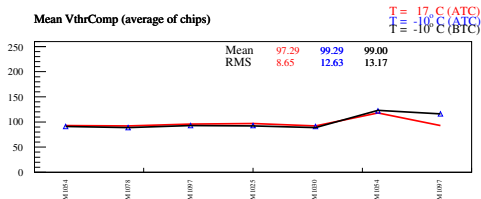
Mean CalDel (average of chips)



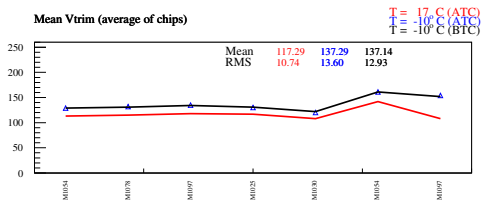
Operational parameters II

Mean DACs II

Mean VthrComp (average of chips)

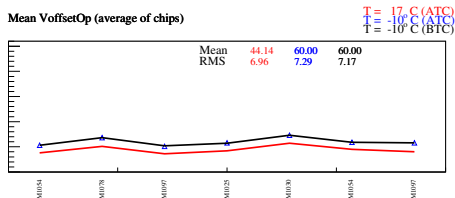
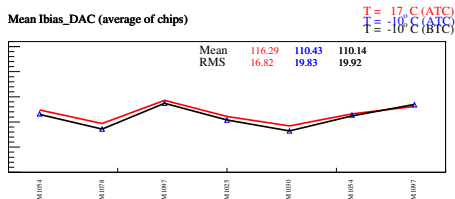


Mean Vtrim (average of chips)



Operational parameters III

Mean DACs III

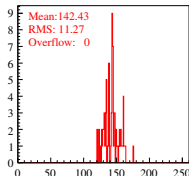


Operational parameters at $T = +17^{\circ}\text{C}$ (ATC)

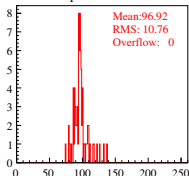
DAC distribution (of chips)

DACs at $T = 17^{\circ}\text{C}$ (ATC)

Vana

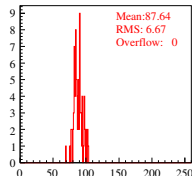


VthrComp

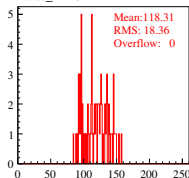


Modules: M1054 ... M1097

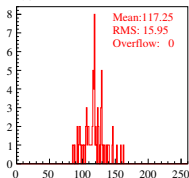
CalDel



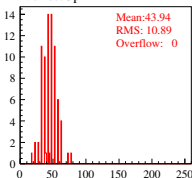
Ibias_DAC



Vtrim

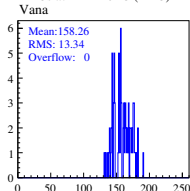


VoffsetOp

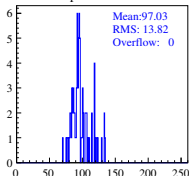


Operational parameters at $T = -10^{\circ}\text{C}$ (ATC)

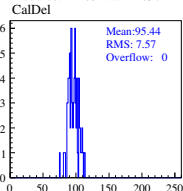
DAC distribution (of chips)

DACs at $T = -10^{\circ}\text{C}$ (ATC)

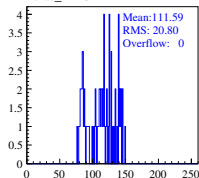
VthrComp



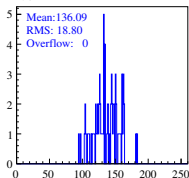
Modules: M1054 ... M1097



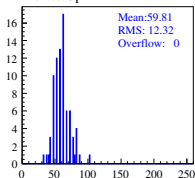
Ibias_DAC



Vtrim



VoffsetOp

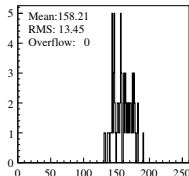


Operational parameters at $T = +17^{\circ}\text{C}$ (BTC)

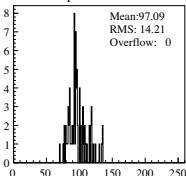
DAC distribution (of chips)

DACs at $T = -10^{\circ}\text{C}$ (BTC)

Vana

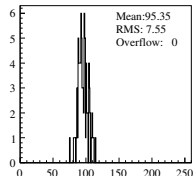


VthrComp

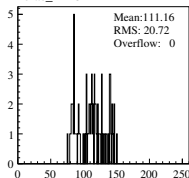


Modules: M1054 ... M1097

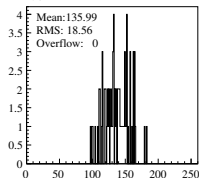
CalDel



Ibias_DAC



Vtrim



VoffsetOp

